MUR220

Preferred Device

SWITCHMODE™ Power Rectifier

These state-of-the-art devices are designed for use in switching power supplies, inverters and as free wheeling diodes.

Features

- Ultrafast 25 Nanosecond Recovery Times
- 175°C Operating Junction Temperature
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction
- These are Pb–Free Devices*

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 0.4 Gram (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Polarity: Cathode Indicated by Polarity Band

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	200 -	V
Average Rectified Forward Current (Note 1) (Square Wave Mounting Method #3 Per Note 3)	I _{F(AV)}	2.0 @ T _A = 90°C	A
Non–Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I _{FSM}	35	A
Operating Junction Temperature and Storage Temperature Range	T _J , T _{stg}	– 65 to +175	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Ambient	R_{\thetaJA}	(Note 3)	°C/W

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

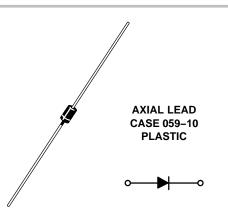
1. Pulse Test: Pulse Width = 300 μ s, Duty Cycle \leq 2.0%.



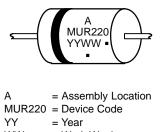
ON Semiconductor®

http://onsemi.com

ULTRAFAST RECTIFIER 2.0 AMPERES – 200 VOLTS



MARKING DIAGRAM



- WW = Work Week
- = Pb–Free Package
 (Note: Microdot may be in either location)

(Note: Microdot may be in entier location,

ORDERING INFORMATION

Device	Package	Shipping [†]
MUR220	Axial Lead**	1000 Units / Bulk
MUR220G	Axial Lead**	1000 Units / Bulk
MUR220RL	Axial Lead**	5000 / Tape & Reel
MUR220RLG	Axial Lead**	5000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Preferred devices are recommended choices for future use

**This package is inherently Pb-Free.

and best overall value.

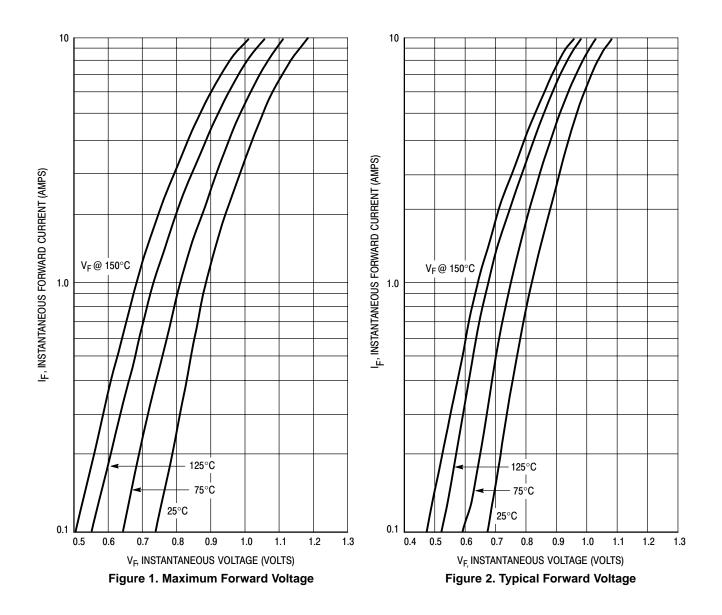
*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

Reference Manual, SOLDERRM/D.

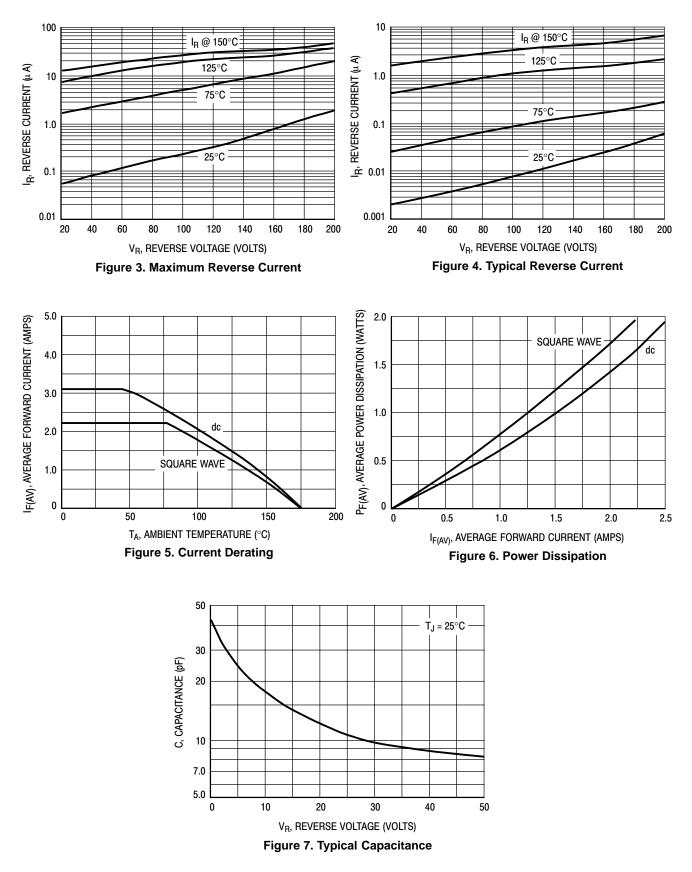
ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (Note 2) ($I_F = 2.0 \text{ Amp}, T_J = 150^{\circ}\text{C}$) ($I_F = 2.0 \text{ Amp}, T_J = 25^{\circ}\text{C}$)	VF	0.75 0.95	V
Maximum Instantaneous Reverse Current (Note 2) (Rated dc Voltage, $T_J = 150^{\circ}C$) (Rated dc Voltage, $T_J = 25^{\circ}C$)	i _R	50 2.0	μΑ
Maximum Reverse Recovery Time ($I_F = 1.0 \text{ Amp, di/dt} = 50 \text{ Amp/}\mu s$) ($I_F = 0.5 \text{ Amp, } I_R = 1.0 \text{ Amp, } I_{REC} = 0.25 \text{ A}$)	t _{rr}	35 25	ns
Maximum Forward Recovery Time (I _F = 1.0 A, di/dt = 100 A/μs, I _{REC} to 1.0 V)	t _{fr}	25	ns

2. Pulse Test: Pulse Width = 300 μ s, Duty Cycle \leq 2.0%.



MUR220



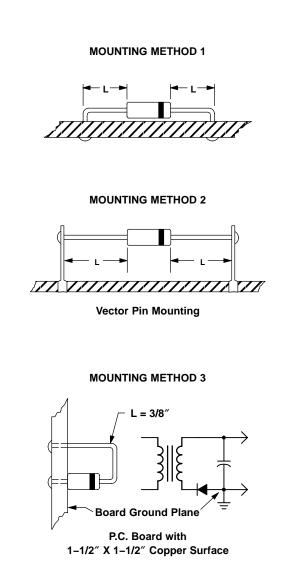
MUR220

NOTE 3. – AMBIENT MOUNTING DATA

Data shown for Thermal Resistance, Junction–to–Ambient ($R_{\theta JA}$) for the mountings shown is to be used as typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

TYPICAL VALUES FOR $\textbf{R}_{\theta \textbf{JA}}$ IN STILL AIR

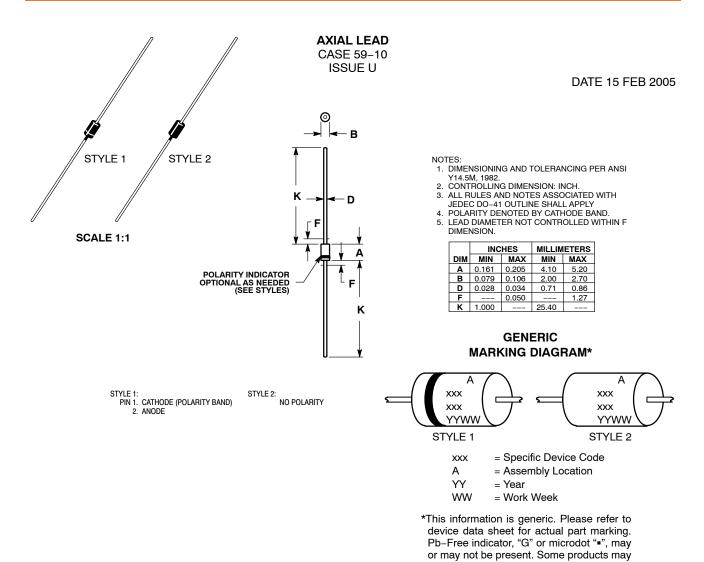
Mounti	ng	Lead Length, L			
Metho	Method 1/8 1/-		Method 1/8 1/4 1/2		Units
1		52	65	72	°C/W
2	$R_{\theta JA}$	67	80	87	°C/W
3			50		°C/W



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not follow the Generic Marking.



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